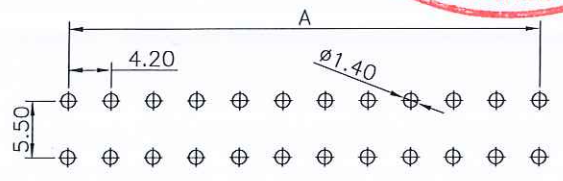
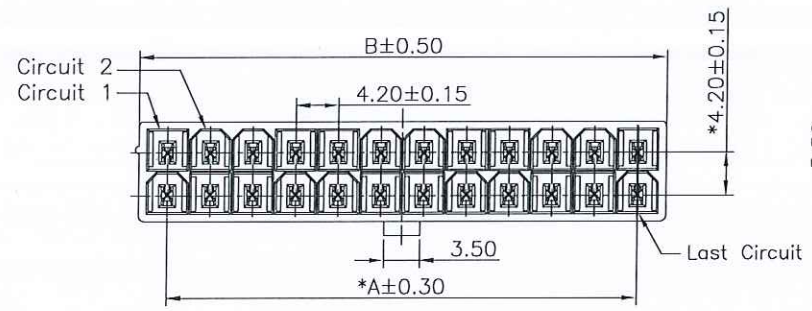




The product using material and processing must conform to the "WI-PZ-001" HSF technical standard control requirements

RoHS



RECOMMENDED PCB LAYOUT  
(GENERAL TOLERANCE: ±0.05)

- NOTE:
- MATERIAL SPECIFICATION:
    - HOUSING: PA66/ LCP
    - CONTACTS: BRASS
  - PLATING SPECIFICATION:
    - CONTACTS: TIN/GOLD FLASH PLATED OVER ALL.
  - ELECTRICAL PERFORMANCE:
    - CURRENT RATING: 9A
    - CONTACT RESISTANCE: 10 mΩ MAX
    - INSULATION RESISTANCE: 1000MΩ Min
    - DIELECTRIC WITHSTANDING : 1500V
  - ENVIRONMENTAL PERFORMANCE:
    - OPERATING TEMPERATURE: -25°C~+85°C/PA66
    - OPERATING TEMPERATURE: -40°C~+105°C/LCP
  - PACKAGE SPEC: TRAY
  - P/N:

C4201 W 0 3-2 XX 1 X X X

SERIES NO: \_\_\_\_\_

CONNECTOR: \_\_\_\_\_

W-WAFER

ANGLE: \_\_\_\_\_

0-180°

TYPE: \_\_\_\_\_

3-TYPE 3

ROW NO: \_\_\_\_\_

2-DOUBLE ROW

PIN Q' PY: \_\_\_\_\_

02~24

HOUSING

0-PA66,UL94V-0

2-PA66,UL94V-2

3-LCP,UL94V-0(RoHS+HF)

COLOR:

A-BLACK

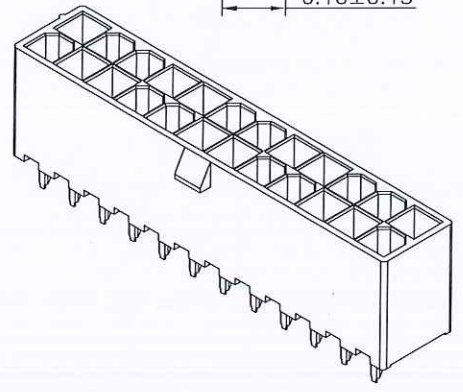
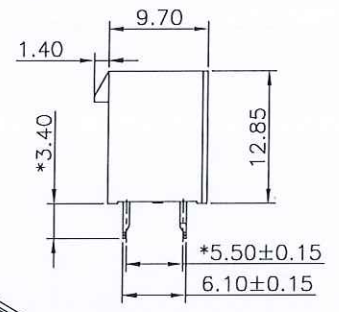
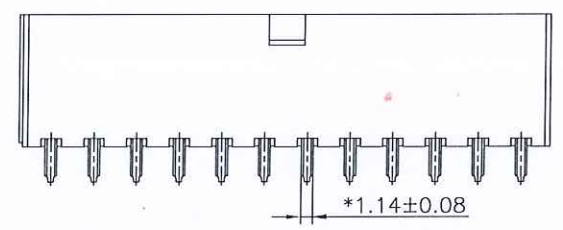
S-NATURE

PLATING:

C-BRIGHE TIN

TERMIPOINT:

1-DIP



Ordering Information & Dimensions

Circuit	Dimensions(mm)		Circuit	Dimensions(mm)	
	A	B		A	B
2*01	---	5.60	2*07	25.20	30.80
2*02	4.20	9.80	2*08	29.40	35.00
2*03	8.40	14.00	2*09	33.60	39.20
2*04	12.60	18.20	2*10	37.80	43.40
2*05	16.80	22.40	2*11	42.00	47.60
2*06	21.00	26.60	2*12	46.20	51.80

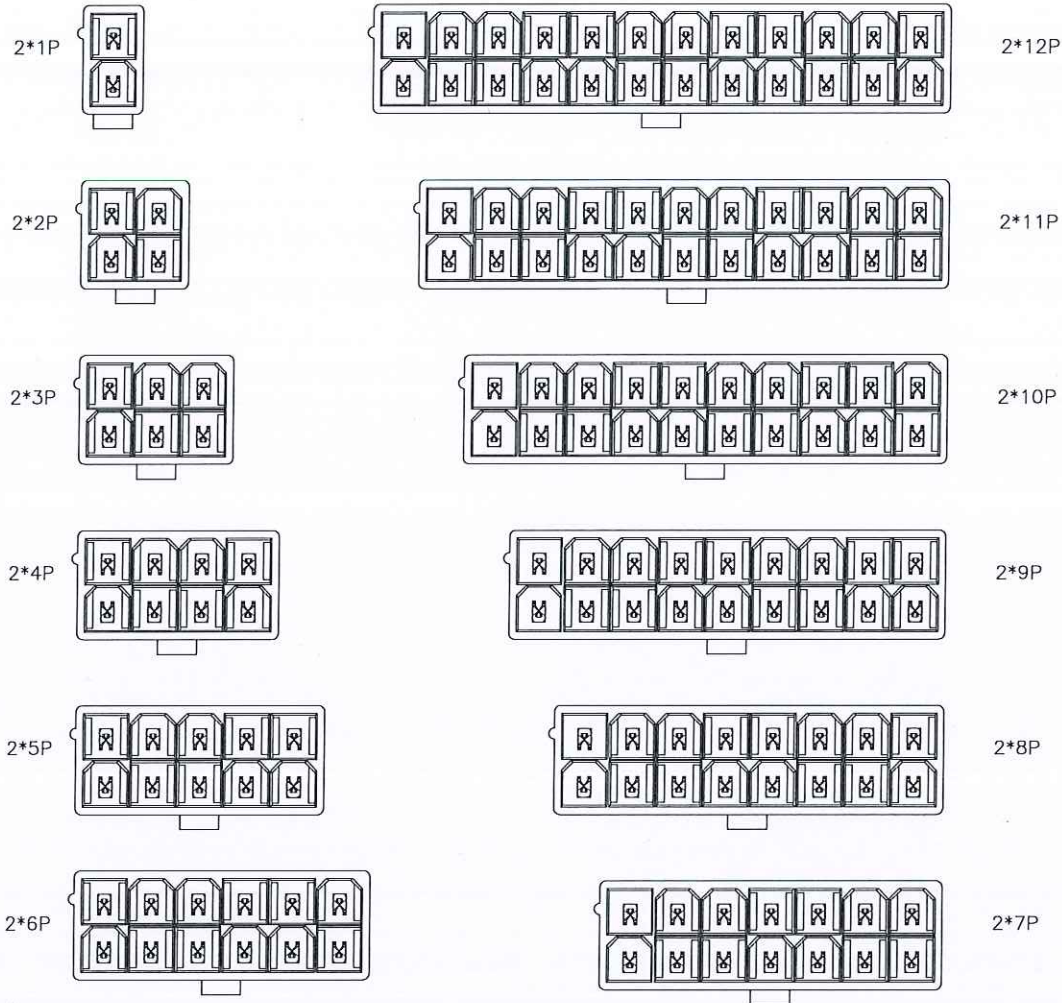
REV.	REVISION RECORD	DATE	GENERAL TOLERANCES	SCALE:	NAME	DATE	PART.NO:	DWG.NO:
A0	NEW RELEASE	21.11.17	LINEAR	1:1			C4201W03-2XX1XXX	ENDE05
A1	PART NUMBER RENEWAL	23.09.08	0.0±0.35	APPROVED	nanji	2026.06.01		
A2	UPDATE PACKAGING SPECIFICATIONS	26.06.01	0.00±0.25	DESIGNER	mxz	2026.6.1	TITLE:	
			0.000±0.10	DRAWN	HUANG JUAN	26.06.01	Pitch 4.2mm 双排 180° DIP Wafer 空心针	



REV: A1 SHEET: 1/3

The product using material and processing must conform to the "WI-PZ-001"HSF technical standard control requirements

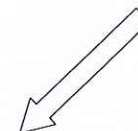
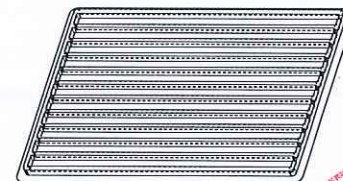
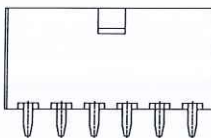
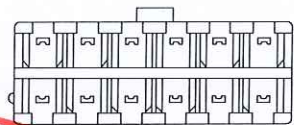
RoHS



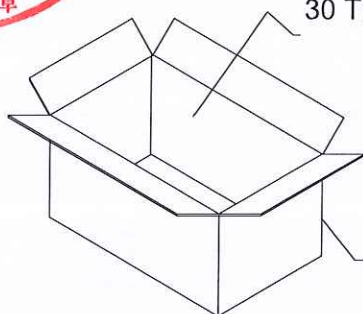
REV.	REVISION RECORD	DATE	UNIT: mm	GENERAL TOLERANCES		SCALE: 1:1	NAME	DATE	PART.NO:	DWG.NO:	 WanLian Technology Co., Ltd
A0	NEW RELEASE	21.11.17		LINEAR	ANGLES	APPROVED	<i>Wangji</i>	2026.6.1	C4201W03-2XX1XXX	ENDE05	
A1	PART NUMBER RENEWAL	23.09.08	SIZE: A4	0.0±0.35	X'REF±6°	DESIGNER	<i>MMJ</i>	2026.6.1	TITLE: Pitch 4.2mm 双排 180° DIP Wafer 空心针	REV: A2	SHEET: 2/3
A2	UPDATE PACKAGING SPECIFICATIONS	26.06.01		0.00±0.25	X'±3'	DRAWN	Zijun_Huang	26.06.01			

The product using material and processing must conform to the "WI-PZ-001"HSF technical standard control requirements

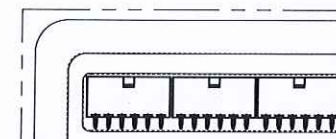
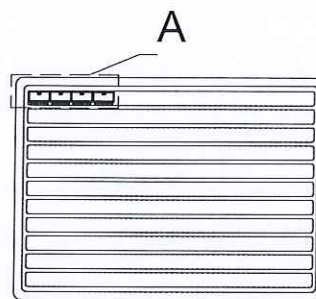
RoHS



30 Trays/Box carton



Material: K=K



A  
4:1

A2

Circuits	PCS/Tray	30Trays/Carton	Circuits	PCS/Tray	30Trays/Carton
2*1P 无柱	649	19470	2*7P 无柱	121	3630
2*2P 无柱	374	11220	2*8P 无柱	99	2970
2*3P 无柱	264	7920	2*9P 无柱	88	2640
2*4P 无柱	198	5940	2*10P 无柱	88	2640
2*5P 无柱	165	4950	2*11P 无柱	77	2310
2*6P 无柱	132	3960	2*12P 无柱	66	1980

注意事项:

- 1.盒装产品四周需用胶纸固定(一盘一盖);袋装产品封口前需放1-2包干燥剂于内;卷装产品前后需留10-20PCS产品空格。
- 2.产品不可少数、多数,方向须一致。
- 3.内外包装均需有数量标签,尾数包装需用不影响品质之物品填充并注明尾数。
- 4.所有PIN位6盘/捆(用PE膜缠绕),5捆/箱
- 5.纸箱规格:39.5X28.5X39.5CM

REV.	REVISION RECORD	DATE	GENERAL TOLERANCES		SCALE:	NAME	DATE	PART.NO:	DWG.NO:
A0	NEW RELEASE	21.11.17	 UNIT: mm SIZE: A4	LINEAR	1:1	 2026.6.1	2026.6.1	C4201W03-2XX1XXX	ENDE05
A1	PART NUMBER RENEWAL	23.09.08		ANGLES	APPROVED				
A2	UPDATE PACKAGING SPECIFICATIONS	26.06.01	0.0±0.35	X'REF±6'	DESIGNER	 2026.6.1		TITLE:	 WanLian Technology Co., Ltd
			0.00±0.25	X'±3'	DRAWN	HUANG JUAN	26.06.01	包装图	REV: A2 SHEET: 3/3
			0.000±0.10	X'X' ±2'					